

**Vishay Siliconix** 

RoHS

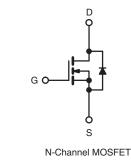
COMPLIANT



### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
R <sub>DS(on)</sub> (Ω)	$V_{GS} = 10 V$	0.018		
Q <sub>g</sub> (Max.) (nC)	110			
Q <sub>gs</sub> (nC)	29			
Q <sub>gd</sub> (nC)	38			
Configuration	Single			





#### FEATURES

- Dynamic dV/dt Rating
- Isolated Central Mounting Hole
- 175 °C Operating Temperature
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole. It also provides greater creepage distances between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION		
Package	TO-247AC	
Lead (Pb)-free	IRFP048PbF	
	SiHFP048-E3	
SnPb	IRFP048	
	SiHFP048	

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \text{ °C}$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	60	v	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current <sup>e</sup>	V <sub>GS</sub> at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$		70		
Continuous Drain Current	VGS AL TO V	T <sub>C</sub> = 100 °C		52	A	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	290		
Linear Derating Factor				1.3	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	200	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		PD	190	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature) <sup>d</sup>	for 10 s			300		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 43 µH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 73 A (see fig. 12).

c.  $I_{SD} \le 72$  A, dI/dt  $\le 200$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.

d. 1.6 mm from case.

e. Current limited by the package (die current = 73 A).

\* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91198 S11-0447-Rev. B, 14-Mar-11 www.vishay.com

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.80		

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference t	o 25 °C, I <sub>D</sub> = 1 mA	-	0.060	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_0$	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Zaura Oasta Malta era Durain Orumant	1	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V, V <sub>0</sub>	<sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	$I_D = 44 \text{ A}^{b}$	-	-	0.018	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 25 \text{ V}, \text{ I}_{D} = 44 \text{ A}^{b}$		20	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	2400	-	pF
Output Capacitance	C <sub>oss</sub>			-	1300	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	190	-	
Total Gate Charge	Qg			-	-	110	nC
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 \text{ V}$	I <sub>D</sub> = 72 A, V <sub>DS</sub> = 48 V see fig. 6 and 13 <sup>b</sup>	-	-	29	
Gate-Drain Charge	Q <sub>gd</sub>	_	see lig. 0 and 13	-	-	38	
Turn-On Delay Time	t <sub>d(on)</sub>		•	-	8.1	-	
Rise Time	t <sub>r</sub>	$V_{DD}=30~V,~I_D=72~A, \label{eq:prod} R_g=9.1~\Omega,~R_D=0.34~\Omega,~\text{see fig. }10^b$		-	250	-	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	210	-	
Fall Time	t <sub>f</sub>			-	250	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	nЦ
Internal Source Inductance	L <sub>S</sub>			-	13	-	nH
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	70 <sup>c</sup>	А
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	290	
Body Diode Voltage	$V_{SD}$	$T_J = 25 \text{ °C}, I_S = 73 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 72 A, dl/dt = 100 A/µs <sup>b</sup>		-	120	180	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.50	0.80	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-	-on time is negligible (turr	I-on is do	minated b	v Le and	Ln)

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.

c. Current limited by the package (die current = 73 A).

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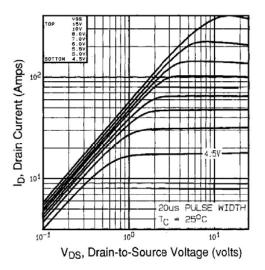


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

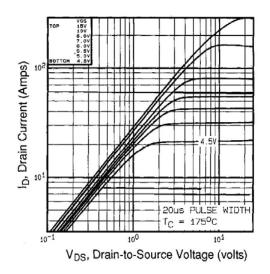


Fig. 2 - Typical Output Characteristics,  $T_C = 175 \ ^\circ C$ 

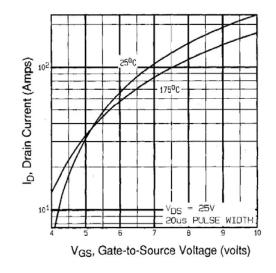


Fig. 3 - Typical Transfer Characteristics

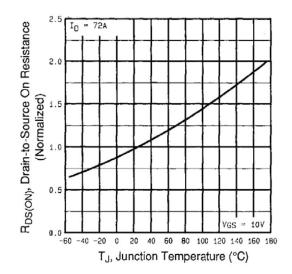


Fig. 4 - Normalized On-Resistance vs. Temperature

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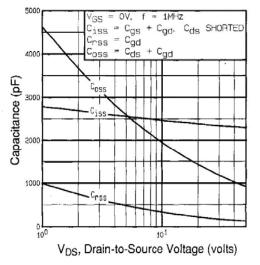


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

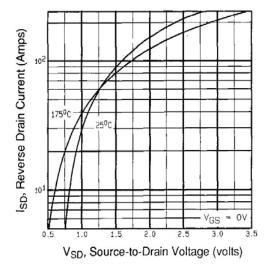


Fig. 7 - Typical Source-Drain Diode Forward Voltage

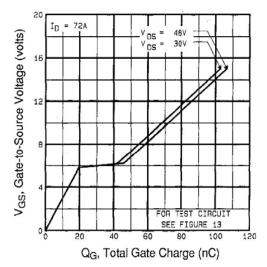
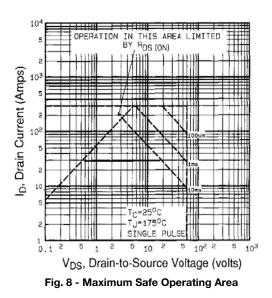


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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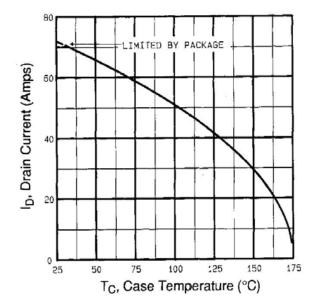


Fig. 9 - Maximum Drain Current vs. Case Temperature

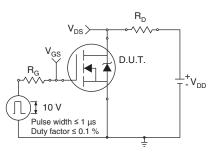


Fig. 10a - Switching Time Test Circuit

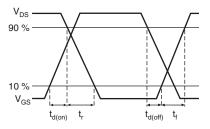


Fig. 10b - Switching Time Waveforms

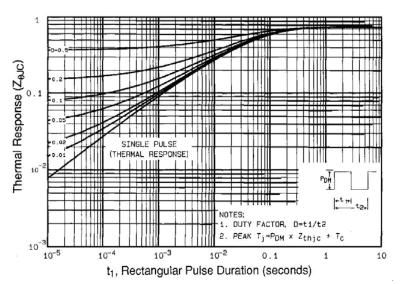


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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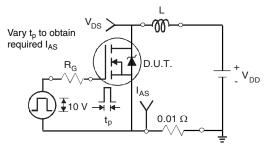


Fig. 12a - Unclamped Inductive Test Circuit

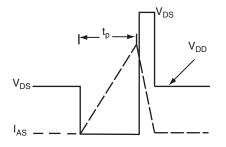


Fig. 12b - Unclamped Inductive Waveforms

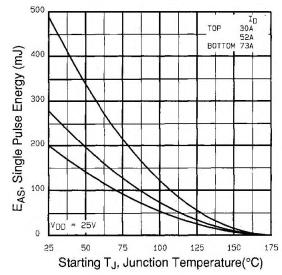
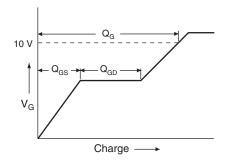


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





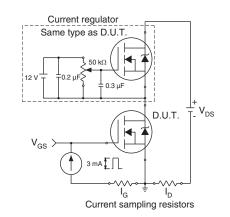


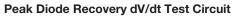
Fig. 13b - Gate Charge Test Circuit

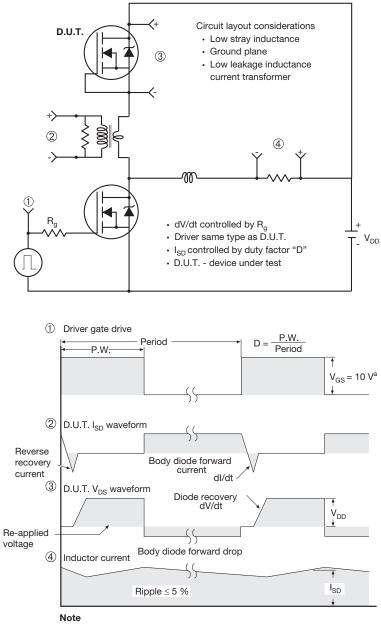
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a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91198">www.vishay.com/ppg?91198</a>.

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## TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

#### Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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